

# Alpha & Omega Semiconductor Product Reliability qualification Report

## AONE38132, rev C

**Plastic Encapsulated Device** 

**ALPHA & OMEGA Semiconductor, Inc** 

www.aosmd.com



This AOS product reliability report summarizes the qualification result for AONE38132. Accelerated environmental tests are performed on a specific sample size, and then followed by electrical test at end point. Review of final electrical test result confirms that AONE38132 passes AOS quality and reliability requirements. The released product will be categorized by the process family and be routine monitored for continuously improving the product quality.

| Test Item            | Test Condition                                           | Time Point   | Total<br>Sample<br>Size | Number<br>of<br>Failures | Reference<br>Standard      |
|----------------------|----------------------------------------------------------|--------------|-------------------------|--------------------------|----------------------------|
| HTGB                 | Temp = 150°C ,<br>Vgs=100% of Vgsmax                     | 1000 hrs     | 231 pcs                 | 0                        | JESD22-A108                |
| HTRB                 | Temp = 150°C,<br>Vds=100% of Vdsmax                      | 1000 hrs     | 231 pcs                 | 0                        | JESD22-A108                |
| HAST                 | 168hr 85°C / 85%RH +<br>3 cycle reflow@260°C<br>(MSL 1)* | -            | 231 pcs                 | 0                        | JESD22-A113                |
|                      | 130°C , 85%RH,<br>33.3 psia,<br>Vds = 80% of Vdsmax      | 96 hrs       | 231 pcs                 | 0                        | ESD22-A110                 |
| H3TRB                | 168hr 85°C / 85%RH +<br>3 cycle reflow@260°C<br>(MSL 1)* | -            | 231 pcs                 | 0                        | JESD22-A113                |
|                      | 85°C , 85%RH,<br>Vds = 80% of Vdsmax                     | 1000 hrs     |                         | 0                        | JESD22-A101                |
| Autoclave            | 168hr 85°C / 85%RH +<br>3 cycle reflow@260°C<br>(MSL 1)* | -            | 231 pcs                 | 0                        | JESD22-A113                |
|                      | 121°C , 29.7psia,<br>RH=100%                             | 96 hrs       | 231 pcs                 | 0                        | JESD22-A102                |
| Temperature<br>Cycle | 168hr 85°C / 85%RH +<br>3 cycle reflow@260°C<br>(MSL 1)* | -            | 231 pcs                 | 0                        | JESD22-A113                |
|                      | -65°C to 150°C,<br>air to air                            | 1000 cycles  | 231 pcs                 | 0                        | JESD22-A104                |
| IOL                  | 168hr 85°C / 85%RH +<br>3 cycle reflow@260°C<br>(MSL 1)* | -            | 231 pcs                 | 0                        | JESD22-A113                |
|                      | ∆ Tj = 100°C                                             | 10000 cycles | 201 pcs                 | 0                        | MIL-STD-750<br>Method 1037 |

### I. Reliability Stress Test Summary and Results

**Note:** The reliability data presents total of available generic data up to the published date. \*: MSL (Moisture Sensitivity Level) 1 based on J-STD-020

#### **II. Reliability Evaluation**

#### FIT rate (per billion): 7.63 MTTF = 14960 years

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.



Failure Rate =  $Chi^2 \times 10^9 / [2 (N) (H) (Af)] = 7.63$ MTTF =  $10^9 / FIT = 14960$  years

**Chi**<sup>2</sup> = Chi Squared Distribution, determined by the number of failures and confidence interval  $\mathbf{N}$  = Total Number of units from burn-in tests

 $\mathbf{H}$  = Duration of burn-in testing

**Af** = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse =  $55^{\circ}C$ ) Acceleration Factor [**Af**] = **Exp** [Ea / k (1/Tj u - 1/Tj s)]

#### Acceleration Factor ratio list:

|    | 55 deg C | 70 deg C | 85 deg C | 100 deg C | 115 deg C | 130 deg C | 150 deg C |
|----|----------|----------|----------|-----------|-----------|-----------|-----------|
| Af | 259      | 87       | 32       | 13        | 5.64      | 2.59      | 1         |

Tj s = Stressed junction temperature in degree (Kelvin), K = C+273.16

Tj u =The use junction temperature in degree (Kelvin), K = C+273.16

 $\mathbf{k}$  = Boltzmann's constant, 8.617164 X 10<sup>-5</sup>eV / K